## Integrated Circuits Division

| Parameter | Rating | Units |
| :--- | :---: | :---: |
| Blocking Voltage | 350 | $V_{P}$ |
| Load Current | 100 | $\mathrm{~mA}_{\mathrm{rms}} / \mathrm{mA}_{\mathrm{DC}}$ |
| On-Resistance (max) | 35 | $\Omega$ |

## Features

- $3750 \mathrm{~V}_{\text {rms }}$ Input/Output Isolation
- Three Functions in One Package
- Bidirectional Current Sensing
- Bidirectional Current Switching
- FCC Compatible
- No EMI/RFI Generation
- Small 16-Pin SOIC Package
- Tape \& Reel Versions Available


## Applications

- Telecommunications
- Telecom Switching
- Tip/Ring Circuits
- Modem Switching (Laptop, Notebook, Pocket Size)
- Hook Switch
- Dial Pulsing
- Ground Start
- Ringing Injection
- Instrumentation
- Multiplexers
- Data Acquisition
- Electronic Switching
- I/O Subsystems
- Meters (Watt-Hour, Water, Gas)
- Medical Equipment-Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls


## Description

The IBB110P Multifunction Telecom switch combines two 350V normally closed (1-Form-B) relays and one optocoupler in a single package. The relays use optically coupled MOSFET technology to provide $1500 \mathrm{~V}_{\text {rms }}$ of input to output isolation. The efficient MOSFET switches and photovoltaic die use IXYS Integrated Circuits Division's patented OptoMOS architecture, while the optically coupled output is controlled by highly efficient infrared LEDs. Circuit designers using the IBB110P can combine three discrete functions in a single package, thus using less space than traditional discrete component solutions.

## Approvals

- UL Recognized Component: File E76270
- CSA Certified Component: Certificate 1305490
- EN62368-1 Certified Component:

TUV Certificate: B 0826670008 Rev 00

## Ordering Information

| Part \# | Description |
| :--- | :--- |
| IBB110P | 16-Pin SOIC (50/Tube) |
| IBB110PTR | 16-Pin SOIC (1000/Reel) |

Pin Configuration
(N/C)


Absolute Maximum Ratings @ $25^{\circ} \mathrm{C}$

| Parameter | Symbol | Ratings | Units |
| :--- | :---: | :---: | :---: |
| Input Control Current, Relay | $\mathrm{I}_{\mathrm{F}}$ | 50 | mA |
| Total Package Dissipation ${ }^{1}$ | $\mathrm{P}_{\mathrm{T}}$ | 1 | W |
| Isolation Voltage, Input to Output | $\mathrm{V}_{\text {ISO }}$ | 3750 | $\mathrm{~V}_{\text {rms }}$ |
| Operational Temperature | $\mathrm{T}_{\mathrm{A}}$ | -40 to +85 | ${ }^{\circ} \mathrm{C}$ |
| Storage Temperature | $\mathrm{T}_{\text {STG }}$ | -40 to +125 | ${ }^{\circ} \mathrm{C}$ |

${ }^{1}$ Derate linearly $1.67 \mathrm{~mW} /{ }^{\circ} \mathrm{C}$

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Typical values are characteristic of the device at $+25^{\circ} \mathrm{C}$, and are the result of engineering evaluations. They are provided for information purposes only, and are not part of the manufacturing testing requirements.

Electrical Characteristics @ $\mathbf{2 5}^{\circ} \mathrm{C}$ : Relay Section

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Blocking Voltage (Peak) | - | V | - | - | 350 | $V_{P}$ |
| Load Current Continuous | - | $I_{\text {L }}$ | - | - | 100 | $m A_{\text {rms }} / \mathrm{mA}_{\text {DC }}$ |
| Peak | $\mathrm{t}=10 \mathrm{~ms}$ | LLPK | - | - | 350 | $m A_{p}$ |
| On-Resistance | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ | $\mathrm{R}_{\text {ON }}$ | - | - | 35 | $\Omega$ |
| Off-State Leakage Current | $\mathrm{V}_{\mathrm{L}}=350 \mathrm{~V}, \mathrm{~T}_{\mathrm{J}}=25^{\circ} \mathrm{C}$ | $\mathrm{I}_{\text {LEAK }}$ | - | - | 1 | $\mu \mathrm{A}$ |
| Switching Speeds Turn-On |  | $\mathrm{t}_{\text {on }}$ | - | - | 3 | ms |
| Turn-Off |  | $\mathrm{t}_{\text {off }}$ | - | - | 3 | ms |
| Output Capacitance | $\mathrm{V}_{\mathrm{L}}=50 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{\text {OUT }}$ | - | 25 | - | pF |
| Input Characteristics |  |  |  |  |  |  |
| Input Control Current to Activate | $\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}$ | $I_{F}$ | - | - | 5 | mA |
| Input Control Current to Deactivate | $\mathrm{I}_{\mathrm{L}}=1 \mathrm{~mA}$ | $I_{F}$ | 0.4 | - | - | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.4 | V |
| Reverse Input Voltage | - | $\mathrm{V}_{\text {R }}$ | - | - | 5 | V |
| Reverse Input Current | $\mathrm{V}_{\mathrm{R}}=5 \mathrm{~V}$ | $\mathrm{I}_{\text {R }}$ | - | - | 10 | $\mu \mathrm{A}$ |

Electrical Characteristics @ $\mathbf{2 5}^{\circ} \mathrm{C}$ : Detector Section

| Parameter | Conditions | Symbol | Min | Typ | Max | Units |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| Output Characteristics |  |  |  |  |  |  |
| Phototransistor Blocking Voltage | $\mathrm{I}_{\mathrm{C}}=10 \mu \mathrm{~A}$ | $\mathrm{BV}_{\text {CEO }}$ | 20 | 50 | - | V |
| Phototransistor Dark Current | $\mathrm{V}_{\mathrm{CE}}=5 \mathrm{~V}, \mathrm{I}_{\mathrm{F}}=0 \mathrm{~mA}$ | $\mathrm{I}_{\text {cEo }}$ | - | 50 | 500 | nA |
| Saturation Voltage | $\mathrm{I}_{\mathrm{C}}=2 \mathrm{~mA}, \mathrm{I}_{\mathrm{F}}=16 \mathrm{~mA}$ | $V_{\text {SAT }}$ | - | 0.3 | 0.5 | V |
| Current Transfer Ratio | $\mathrm{I}_{\mathrm{F}}=6 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=0.5 \mathrm{~V}$ | CTR | 33 | - | - | \% |
| Input Characteristics |  |  |  |  |  |  |
| Input Control Current | $\mathrm{I}_{\mathrm{C}}=2 \mathrm{~mA}, \mathrm{~V}_{\mathrm{CE}}=0.5 \mathrm{~V}$ | $I_{F}$ | - | 2 | 6 | mA |
| Input Voltage Drop | $\mathrm{I}_{\mathrm{F}}=5 \mathrm{~mA}$ | $V_{F}$ | 0.9 | 1.2 | 1.4 | V |
| Input Current (Detector Must be Off) | $\mathrm{I}_{\mathrm{C}}=1 \mu \mathrm{~A}, \mathrm{~V}_{\mathrm{CE}}=5 \mathrm{~V}$ | - | 5 | 25 | - | $\mu \mathrm{A}$ |
| Capacitance, Input to Output | $\mathrm{V}_{\mathrm{L}}=50 \mathrm{~V}, \mathrm{f}=1 \mathrm{MHz}$ | $\mathrm{C}_{1 / 0}$ | - | 3 | - | pF |
| Isolation, Input to Output | - | $\mathrm{V}_{1 / \mathrm{O}}$ | 3750 | - | - | $\mathrm{V}_{\text {rms }}$ |

## RELAY PERFORMANCE DATA*







Typical Blocking Voltage Distribution


Typical Turn-On Time vs. LED Forward Current $\left(\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}_{\mathrm{DC}}\right)$


Typical Turn-Off Time vs. LED Forward Current $\left(\mathrm{I}_{\mathrm{L}}=100 \mathrm{~mA}_{\mathrm{DC}}\right)$


* Unless otherwise noted, data presented in these graphs is typical of device operation at $25^{\circ} \mathrm{C}$.

RELAY PERFORMANCE DATA (cont.)*



* Unless otherwise noted, data presented in these graphs is typical of device operation at $25^{\circ} \mathrm{C}$.

DETECTOR PERFORMANCE DATA*



Typical Collector Current vs. Forward Current


* Unless otherwise noted, data presented in these graphs is typical of device operation at $25^{\circ} \mathrm{C}$.


## Manufacturing Information

Moisture Sensitivity

All plastic encapsulated semiconductor packages are susceptible to moisture ingression. IXYS Integrated Circuits classifies its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, IPC/JEDEC J-STD-020, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a Moisture Sensitivity Level (MSL) classification as shown below, and should be handled according to the requirements of the latest version of the joint industry standard IPC/JEDEC J-STD-033.

| Device | Moisture Sensitivity Level (MSL) Classification |
| :---: | :---: |
| IBB110P | MSL 3 |

## ESD Sensitivity

This product is ESD Sensitive, and should be handled according to the industry standard JESD-625.

## Soldering Profile

Provided in the table below is the IPC/JEDEC J-STD-020 Classification Temperature ( $\mathrm{T}_{\mathrm{C}}$ ) and the maximum dwell time the body temperature of these surface mount devices may be $\left(T_{C}-5\right)^{\circ} \mathrm{C}$ or greater. The Classification Temperature sets the Maximum Body Temperature allowed for these devices during reflow soldering processes.

| Device | Classification Temperature $\left(T_{\mathrm{c}}\right)$ | Dwell Time $\left(\mathrm{t}_{\mathrm{p}}\right)$ | Max Reflow Cycles |
| :---: | :---: | :---: | :---: |
| IBB110P | $245^{\circ} \mathrm{C}$ | 30 seconds | 3 |

## Board Wash

IXYS Integrated Circuits recommends the use of no-clean flux formulations. Board washing to reduce or remove flux residue following the solder reflow process is acceptable provided proper precautions are taken to prevent damage to the device. These precautions include but are not limited to: using a low pressure wash and providing a follow up bake cycle sufficient to remove any moisture trapped within the device due to the washing process. Due to the variability of the wash parameters used to clean the board, determination of the bake temperature and duration necessary to remove the moisture trapped within the package is the responsibility of the user (assembler). Cleaning or drying methods that employ ultrasonic energy may damage the device and should not be used. Additionally, the device must not be exposed to halide flux or solvents.
(e3)

MECHANICAL DIMENSIONS
IBB110P


NOTES:

1. Coplanarity $=0.1016$ (0.004) max.
2. Leadframe thickness does not include solder plating (1000 microinch maximum).

## IBB110PTR Tape \& Reel



For additional information please visit our website at: https://www.ixysic.com

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